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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	896
Number of Logic Elements/Cells	8064
Total RAM Bits	368640
Number of I/O	195
Number of Gates	400000
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-LBGA
Supplier Device Package	256-FTBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc3s400an-4ftg256c

- Sector-based data protection and security features
  - Sector Protect: Write- and erase-protect a sector (changeable)
  - Sector Lockdown: Sector data is unchangeable (permanent)
- 128-byte Security Register
  - Separate from FPGA's unique Device DNA identifier
  - 64-byte factory-programmed identifier unique to the in-system Flash memory
  - 64-byte one-time programmable, user-programmable field
- 100,000 Program/Erase cycles
- 20-year data retention
- Comprehensive programming support
  - In-system prototype programming via JTAG using Xilinx Platform Cable USB and iMPACT software
  - Product programming support using BPM Microsystems programmers with appropriate programming adapter
  - Design examples demonstrating in-system programming from a Spartan-3AN FPGA application

I/O Capabilities

The Spartan-3AN FPGA SelectIO interface supports many popular single-ended and differential standards. Table 4 shows the number of user I/Os as well as the number of differential I/O pairs available for each device/package combination. Some of the user I/Os are unidirectional, input-only pins as indicated in Table 4.

Spartan-3AN FPGAs support the following single-ended standards:

- 3.3V low-voltage TTL (LVTTL)
- Low-voltage CMOS (LVCMOS) at 3.3V, 2.5V, 1.8V, 1.5V, or 1.2V
- 3.3V PCI at 33 MHz or 66 MHz
- HSTL I, II, and III at 1.5V and 1.8V, commonly used in memory applications
- SSTL I and II at 1.8V, 2.5V, and 3.3V, commonly used for memory applications

Spartan-3AN FPGAs support the following differential standards:

- LVDS, mini-LVDS, RSDS, and PPDS I/O at 2.5V or 3.3V
- Bus LVDS I/O at 2.5V
- TMDS I/O at 3.3V
- Differential HSTL and SSTL I/O
- LVPECL inputs at 2.5V or 3.3V

Table 4: **Available User I/Os and Differential (Diff) I/O Pairs**

Package(1)	**TQ144 TQG144**		**FT256 FTG256**		**FG400 FGG400**		**FG484 FGG484**		**FG676 FGG676**	
Body Size (mm)	**20 x 20**(2)		**17 x 17**		**21 x 21**		**23 x 23**		**27 x 27**	
Device(3)	**User**	**Diff**	**User**	**Diff**	**User**	**Diff**	**User**	**Diff**	**User**	**Diff**
XC3S50AN	**108**(4) *(7)*	**50** *(24)*	**144** *(32)*	**64** *(32)*	–	–	–	–	–	–
XC3S200AN	–	–	**195** *(35)*	**90** *(50)*	–	–	–	–	–	–
XC3S400AN	–	–	**195** *(35)*	**90** *(50)*	**311** *(63)*	**142** *(78)*	–	–	–	–
XC3S700AN	–	–	–	–	–	–	**372** *(84)*	**165** *(93)*	–	–
XC3S1400AN	–	–	–	–	–	–	**375** *(87)*	**165** *(93)*	**502** *(94)*	**227** *(131)*

Notes:

1. See Pb and Pb-Free Packaging, page 7 for details on Pb and Pb-free packaging options.
2. The footprint for the TQ(G)144 (22 mm x 22 mm) package is larger than the package body.
3. Each Spartan-3AN FPGA has a pin-compatible Spartan-3A FPGA equivalent, although Spartan-3A FPGAs do not have internal SPI flash and offer more part/package combinations.
4. The number shown in **bold** indicates the maximum number of I/O and input-only pins. The number shown in (*italics*) indicates the number of input-only pins. The differential (Diff) input-only pin count includes both differential pairs on input-only pins and differential pairs on I/O pins within I/O banks that are restricted to differential inputs.

Spartan-3AN FPGA Design Documentation

The functionality of the Spartan®-3AN FPGA family is described in the following documents. The topics covered in each guide are listed below:

- **DS706: Extended Spartan-3A Family Overview**
- **UG331: Spartan-3 Generation FPGA User Guide**
  - Clocking Resources
  - Digital Clock Managers (DCMs)
  - Block RAM
  - Configurable Logic Blocks (CLBs)
    - Distributed RAM
    - SRL16 Shift Registers
    - Carry and Arithmetic Logic
  - I/O Resources
  - Embedded Multiplier Blocks
  - Programmable Interconnect
  - ISE® Design Tools
  - IP Cores
  - Embedded Processing and Control Solutions
  - Pin Types and Package Overview
  - Package Drawings
  - Powering FPGAs
  - Power Management
- **UG332: Spartan-3 Generation Configuration User Guide**
  - Configuration Overview
    - Configuration Pins and Behavior
    - Bitstream Sizes
  - Detailed Descriptions by Mode
    - Master Serial Mode using Xilinx® Platform Flash
    - Master SPI Mode using SPI Serial Flash PROM
    - Internal Master SPI Mode
    - Master BPI Mode using Parallel NOR Flash
    - Slave Parallel (SelectMAP) using a Processor
    - Slave Serial using a Processor
    - JTAG Mode
  - ISE iMPACT Programming Examples
  - MultiBoot Reconfiguration
  - Design Authentication using Device DNA
- **UG333: Spartan-3AN FPGA In-System Flash User Guide**
  - For FPGA applications that write to or read from the In-System Flash memory after configuration
  - SPI_ACCESS interface
  - In-System Flash memory architecture
  - Read, program, and erase commands
  - Status registers
  - Sector Protection and Sector Lockdown features
  - Security Register with Unique Identifier

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Spartan-3AN FPGA Starter Kit

For specific hardware examples, please see the Spartan-3AN FPGA Starter Kit board web page, which has links to various design examples and the user guide.

- **Spartan-3AN FPGA Starter Kit Board Page**
  http://www.xilinx.com/s3anstarter
- **UG334: Spartan-3AN FPGA Starter Kit User Guide**

External Termination Requirements for Differential I/O

LVDS, RSDS, MINI_LVDS, and PPDS I/O Standards

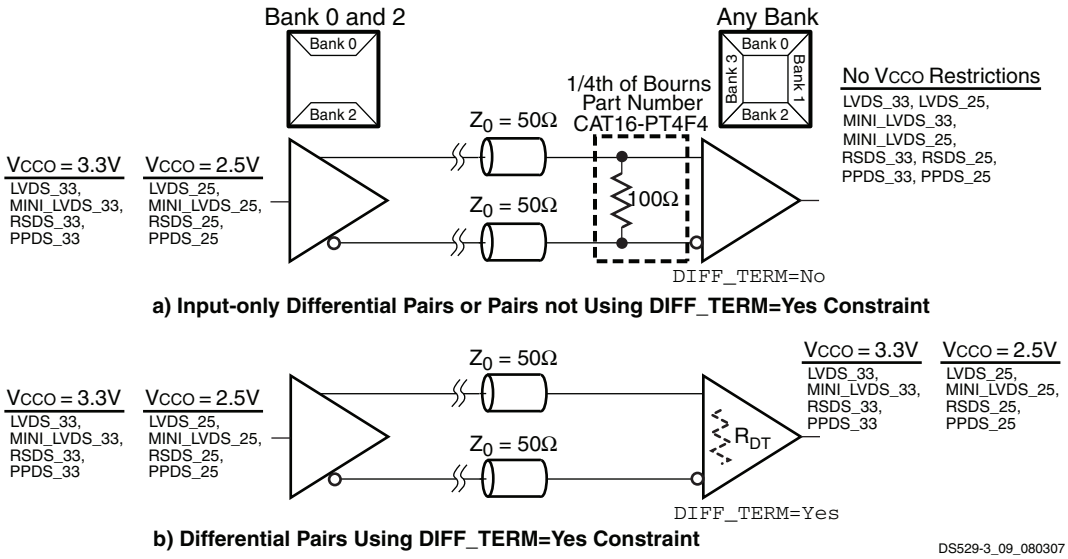

Figure 8: **External Input Termination for LVDS, RSDS, MINI_LVDS, and PPDS I/O Standards**

BLVDS_25 I/O Standard

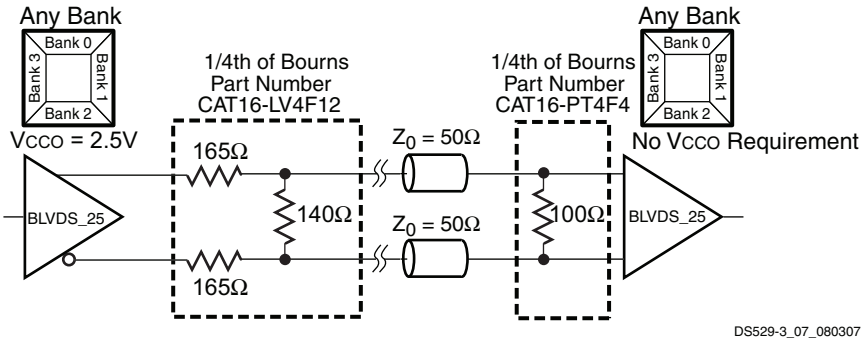

Figure 9: **External Output and Input Termination Resistors for BLVDS_25 I/O Standard**

TMDS_33 I/O Standard

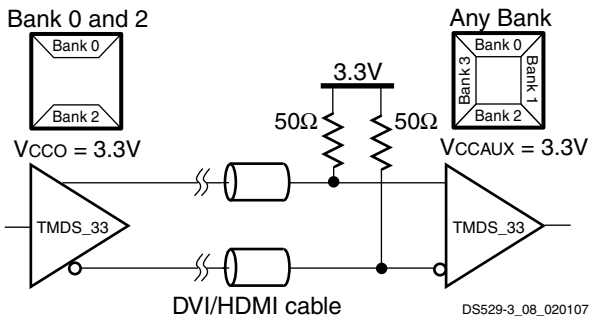

Figure 10: **External Input Resistors Required for TMDS_33 I/O Standard**

Table 29: **Output Timing Adjustments for IOB *(Cont'd)***

Convert Output Time from LVCMOS25 with 12 mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units
			Speed Grade		
			-5	-4	
LVCMOS25	Slow	2 mA	5.33	5.33	ns
		4 mA	2.81	2.81	ns
		6 mA	2.82	2.82	ns
		8 mA	1.14	1.14	ns
		12 mA	1.10	1.10	ns
		16 mA	0.83	0.83	ns
		24 mA	2.26(3)	2.26(3)	ns
	Fast	2 mA	4.36	4.36	ns
		4 mA	1.76	1.76	ns
		6 mA	1.25	1.25	ns
		8 mA	0.38	0.38	ns
		12 mA	0	0	ns
		16 mA	0.01	0.01	ns
		24 mA	0.01	0.01	ns
	QuietIO	2 mA	25.92	25.92	ns
		4 mA	25.92	25.92	ns
		6 mA	25.92	25.92	ns
		8 mA	15.57	15.57	ns
		12 mA	15.59	15.59	ns
		16 mA	14.27	14.27	ns
		24 mA	11.37	11.37	ns

Table 29: **Output Timing Adjustments for IOB *(Cont'd)***

Convert Output Time from LVCMOS25 with 12 mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units
			Speed Grade		
			-5	-4	
LVCMOS18	Slow	2 mA	4.48	4.48	ns
		4 mA	3.69	3.69	ns
		6 mA	2.91	2.91	ns
		8 mA	1.99	1.99	ns
		12 mA	1.57	1.57	ns
		16 mA	1.19	1.19	ns
	Fast	2 mA	3.96	3.96	ns
		4 mA	2.57	2.57	ns
		6 mA	1.90	1.90	ns
		8 mA	1.06	1.06	ns
		12 mA	0.83	0.83	ns
		16 mA	0.63	0.63	ns
	QuietIO	2 mA	24.97	24.97	ns
		4 mA	24.97	24.97	ns
		6 mA	24.08	24.08	ns
		8 mA	16.43	16.43	ns
		12 mA	14.52	14.52	ns
		16 mA	13.41	13.41	ns
LVCMOS15	Slow	2 mA	5.82	5.82	ns
		4 mA	3.97	3.97	ns
		6 mA	3.21	3.21	ns
		8 mA	2.53	2.53	ns
		12 mA	2.06	2.06	ns
	Fast	2 mA	5.23	5.23	ns
		4 mA	3.05	3.05	ns
		6 mA	1.95	1.95	ns
		8 mA	1.60	1.60	ns
		12 mA	1.30	1.30	ns
	QuietIO	2 mA	34.11	34.11	ns
		4 mA	25.66	25.66	ns
		6 mA	24.64	24.64	ns
		8 mA	22.06	22.06	ns
		12 mA	20.64	20.64	ns

Table 32: **Recommended Number of Simultaneously Switching Outputs per V_{CCO}-GND Pair**

Signal Standard (IOSTANDARD)			Package Type			
			TQG144		FTG256, FGG400, FGG484, FGG676	
			Top, Bottom Banks 0,2	Left, Right Banks 1,3	Top, Bottom Banks 0,2	Left, Right Banks 1,3
Single-Ended Standards						
LVTTL	Slow	2	20	20	60	60
		4	10	10	41	41
		6	10	10	29	29
		8	6	6	22	22
		12	6	6	13	13
		16	5	5	11	11
		24	4	4	9	9
	Fast	2	10	10	10	10
		4	6	6	6	6
		6	5	5	5	5
		8	3	3	3	3
		12	3	3	3	3
		16	3	3	3	3
		24	2	2	2	2
	QuietIO	2	40	40	80	80
		4	24	24	48	48
		6	20	20	36	36
		8	16	16	27	27
		12	12	12	16	16
		16	9	9	13	13
		24	9	9	12	12

Table 32: **Recommended Number of Simultaneously Switching Outputs per V_{CCO}-GND Pair *(Cont'd)***

Signal Standard (IOSTANDARD)			Package Type			
			TQG144		FTG256, FGG400, FGG484, FGG676	
			Top, Bottom Banks 0,2	Left, Right Banks 1,3	Top, Bottom Banks 0,2	Left, Right Banks 1,3
LVCMOS33	Slow	2	24	24	76	76
		4	14	14	46	46
		6	11	11	27	27
		8	10	10	20	20
		12	9	9	13	13
		16	8	8	10	10
		24	–	8	–	9
	Fast	2	10	10	10	10
		4	8	8	8	8
		6	5	5	5	5
		8	4	4	4	4
		12	4	4	4	4
		16	2	2	2	2
		24	–	2	–	2
	QuietIO	2	36	36	76	76
		4	32	32	46	46
		6	24	24	32	32
		8	16	16	26	26
		12	16	16	18	18
		16	12	12	14	14
		24	–	10	–	10

Table 40: **Switching Characteristics for the DLL**

Symbol	Description		Device	Speed Grade				Units
				-5		-4		
				Min	Max	Min	Max	
Output Frequency Ranges								
CLKOUT_FREQ_CLK0	Frequency for the CLK0 and CLK180 outputs		All	5	280	5	250	MHz
CLKOUT_FREQ_CLK90	Frequency for the CLK90 and CLK270 outputs			5	200	5	200	MHz
CLKOUT_FREQ_2X	Frequency for the CLK2X and CLK2X180 outputs			10	334	10	334	MHz
CLKOUT_FREQ_DV	Frequency for the CLKDV output			0.3125	186	0.3125	166	MHz
Output Clock Jitter(2,3,4)								
CLKOUT_PER_JITT_0	Period jitter at the CLK0 output		All	–	±100	–	±100	ps
CLKOUT_PER_JITT_90	Period jitter at the CLK90 output			–	±150	–	±150	ps
CLKOUT_PER_JITT_180	Period jitter at the CLK180 output			–	±150	–	±150	ps
CLKOUT_PER_JITT_270	Period jitter at the CLK270 output			–	±150	–	±150	ps
CLKOUT_PER_JITT_2X	Period jitter at the CLK2X and CLK2X180 outputs			–	±[0.5% of CLKIN period + 100]	–	±[0.5% of CLKIN period + 100]	ps
CLKOUT_PER_JITT_DV1	Period jitter at the CLKDV output when performing integer division			–	±150	–	±150	ps
CLKOUT_PER_JITT_DV2	Period jitter at the CLKDV output when performing non-integer division			–	±[0.5% of CLKIN period + 100]	–	±[0.5% of CLKIN period + 100]	ps
Duty Cycle(4)								
CLKOUT_DUTY_CYCLE_DLL	Duty cycle variation for the CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV outputs, including the BUFGMUX and clock tree duty-cycle distortion		All	–	±[1% of CLKIN period + 350]	–	±[1% of CLKIN period + 350]	ps
Phase Alignment(4)								
CLKIN_CLKFB_PHASE	Phase offset between the CLKIN and CLKFB inputs		All	–	±150	–	±150	ps
CLKOUT_PHASE_DLL	Phase offset between DLL outputs	CLK0 to CLK2X (not CLK2X180)		–	±[1% of CLKIN period + 100]	–	±[1% of CLKIN period + 100]	ps
		All others		–	±[1% of CLKIN period + 150]	–	±[1% of CLKIN period + 150]	ps
Lock Time								
LOCK_DLL(3)	When using the DLL alone: The time from deassertion at the DCM's Reset input to the rising transition at its LOCKED output. When the DCM is locked, the CLKIN and CLKFB signals are in phase	5 MHz ≤ F_{CLKIN} ≤ 15 MHz	All	–	5	–	5	ms
		F_{CLKIN} > 15 MHz		–	600	–	600	µs

Phase Shifter (PS)

Table 43: **Recommended Operating Conditions for the PS in Variable Phase Mode**

Symbol	Description	Speed Grade				Units
		-5		-4		
		Min	Max	Min	Max	
Operating Frequency Ranges						
PSCLK_FREQ (F_{PSCLK})	Frequency for the PSCLK input	1	167	1	167	MHz
Input Pulse Requirements						
PSCLK_PULSE	PSCLK pulse width as a percentage of the PSCLK period	40%	60%	40%	60%	%

Table 44: **Switching Characteristics for the PS in Variable Phase Mode**

Symbol	Description		Phase Shift Amount	Units
Phase Shifting Range				
MAX_STEPS(2,3)	Maximum allowed number of DCM_DELAY_STEP steps for a given CLKIN clock period, where T = CLKIN clock period in ns. If using CLKIN_DIVIDE_BY_2 = TRUE, double the clock effective clock period.	CLKIN < 60 MHz	±[INTEGER(10 • (T_{CLKIN} – 3 ns))]	steps
		CLKIN ≥ 60 MHz	±[INTEGER(15 • (T_{CLKIN} – 3 ns))]	
FINE_SHIFT_RANGE_MIN	Minimum guaranteed delay for variable phase shifting		±[MAX_STEPS • DCM_DELAY_STEP_MIN]	ns
FINE_SHIFT_RANGE_MAX	Maximum guaranteed delay for variable phase shifting		±[MAX_STEPS • DCM_DELAY_STEP_MAX]	ns

Notes:

1. The numbers in this table are based on the operating conditions set forth in Table 10 and Table 43.
2. The maximum variable phase shift range, MAX_STEPS, is only valid when the DCM is has no initial fixed phase shifting, that is, the PHASE_SHIFT attribute is set to 0.
3. The DCM_DELAY_STEP values are provided at the bottom of Table 40.

Miscellaneous DCM Timing

Table 45: **Miscellaneous DCM Timing**

Symbol	Description	Min	Max	Units
DCM_RST_PW_MIN	Minimum duration of a RST pulse width	3	–	CLKIN cycles
DCM_RST_PW_MAX(2)	Maximum duration of a RST pulse width	N/A	N/A	seconds
		N/A	N/A	seconds
DCM_CONFIG_LAG_TIME(3)	Maximum duration from V_{CCINT} applied to FPGA configuration successfully completed (DONE pin goes High) and clocks applied to DCM DLL	N/A	N/A	minutes
		N/A	N/A	minutes

Notes:

1. This limit only applies to applications that use the DCM DLL outputs (CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV). The DCM DFS outputs (CLKFX, CLKFX180) are unaffected.
2. This specification is equivalent to the Virtex™-4 FPGA DCM_RESET specification. This specification does not apply for Spartan-3AN FPGAs.
3. This specification is equivalent to the Virtex-4 FPGA T_{CONFIG} specification. This specification does not apply for Spartan-3AN FPGAs.

Suspend Mode Timing

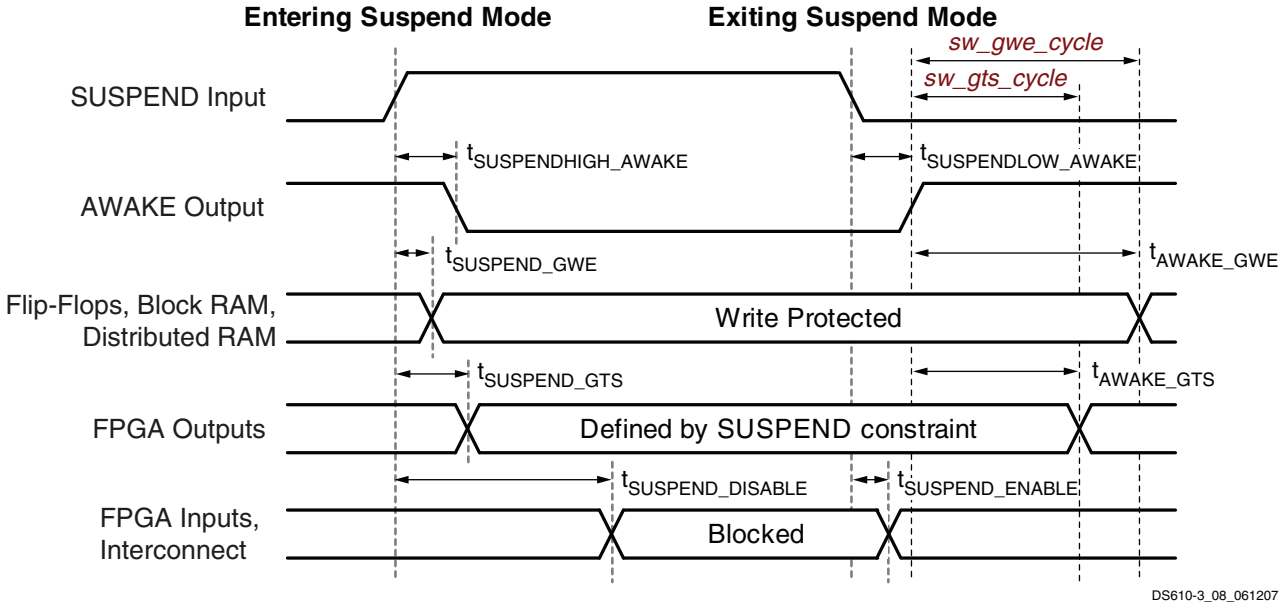

Figure 12: **Suspend Mode Timing**

Table 49: **Suspend Mode Timing Parameters**

Symbol	Description	Min	Typ	Max	Units
Entering Suspend Mode					
$T_{SUSPENDHIGH\_AWAKE}$	Rising edge of SUSPEND pin to falling edge of AWAKE pin without glitch filter (***suspend_filter:No***)	–	7	–	ns
$T_{SUSPENDFILTER}$	Adjustment to SUSPEND pin rising edge parameters when glitch filter enabled (***suspend_filter:Yes***)	+160	+300	+600	ns
$T_{SUSPEND\_GTS}$	Rising edge of SUSPEND pin until FPGA output pins drive their defined SUSPEND constraint behavior	–	10	–	ns
$T_{SUSPEND\_GWE}$	Rising edge of SUSPEND pin to write-protect lock on all writable clocked elements	–	< 5	–	ns
$T_{SUSPEND\_DISABLE}$	Rising edge of the SUSPEND pin to FPGA input pins and interconnect disabled	–	340	–	ns
Exiting Suspend Mode					
$T_{SUSPENDLOW\_AWAKE}$	Falling edge of the SUSPEND pin to rising edge of the AWAKE pin Does not include DCM lock time	–	4 to 108	–	µs
$T_{SUSPEND\_ENABLE}$	Falling edge of the SUSPEND pin to FPGA input pins and interconnect re-enabled	–	3.7 to 109	–	µs
T_{AWAKE_GWE1}	Rising edge of the AWAKE pin until write-protect lock released on all writable clocked elements, using ***sw_clk:InternalClock*** and ***sw_gwe_cycle:1***	–	67	–	ns
T_{AWAKE_GWE512}	Rising edge of the AWAKE pin until write-protect lock released on all writable clocked elements, using ***sw_clk:InternalClock*** and ***sw_gwe_cycle:512***	–	14	–	µs
T_{AWAKE_GTS1}	Rising edge of the AWAKE pin until outputs return to the behavior described in the FPGA application, using ***sw_clk:InternalClock*** and ***sw_gts_cycle:1***	–	57	–	ns
T_{AWAKE_GTS512}	Rising edge of the AWAKE pin until outputs return to the behavior described in the FPGA application, using ***sw_clk:InternalClock*** and ***sw_gts_cycle:512***	–	14	–	µs

Notes:

1. These parameters based on characterization.
2. For information on using the Spartan-3AN Suspend feature, see XAPP480: *Using Suspend Mode in Spartan-3 Generation FPGAs*.

Table 58: **Configuration Timing Requirements for Attached SPI Serial Flash**

Symbol	Description	Requirement	Units
T_{CCS}	SPI serial Flash PROM chip-select time	$T_{CCS} \leq T_{MCCL1} - T_{CCO}$	ns
T_{DSU}	SPI serial Flash PROM data input setup time	$T_{DSU} \leq T_{MCCL1} - T_{CCO}$	ns
T_{DH}	SPI serial Flash PROM data input hold time	$T_{DH} \leq T_{MCCH1}$	ns
T_V	SPI serial Flash PROM data clock-to-output time	$T_V \leq T_{MCCLn} - T_{DCC}$	ns
f_C or f_R	Maximum SPI serial Flash PROM clock frequency (also depends on specific read command used)	$f_C \geq \frac{1}{T_{CCLKn(min)}}$	MHz

Notes:

1. These requirements are for successful FPGA configuration in SPI mode, where the FPGA generates the CCLK signal. The post-configuration timing can be different to support the specific needs of the application loaded into the FPGA.
2. Subtract additional printed circuit board routing delay as required by the application.

Byte Peripheral Interface (BPI) Configuration Timing

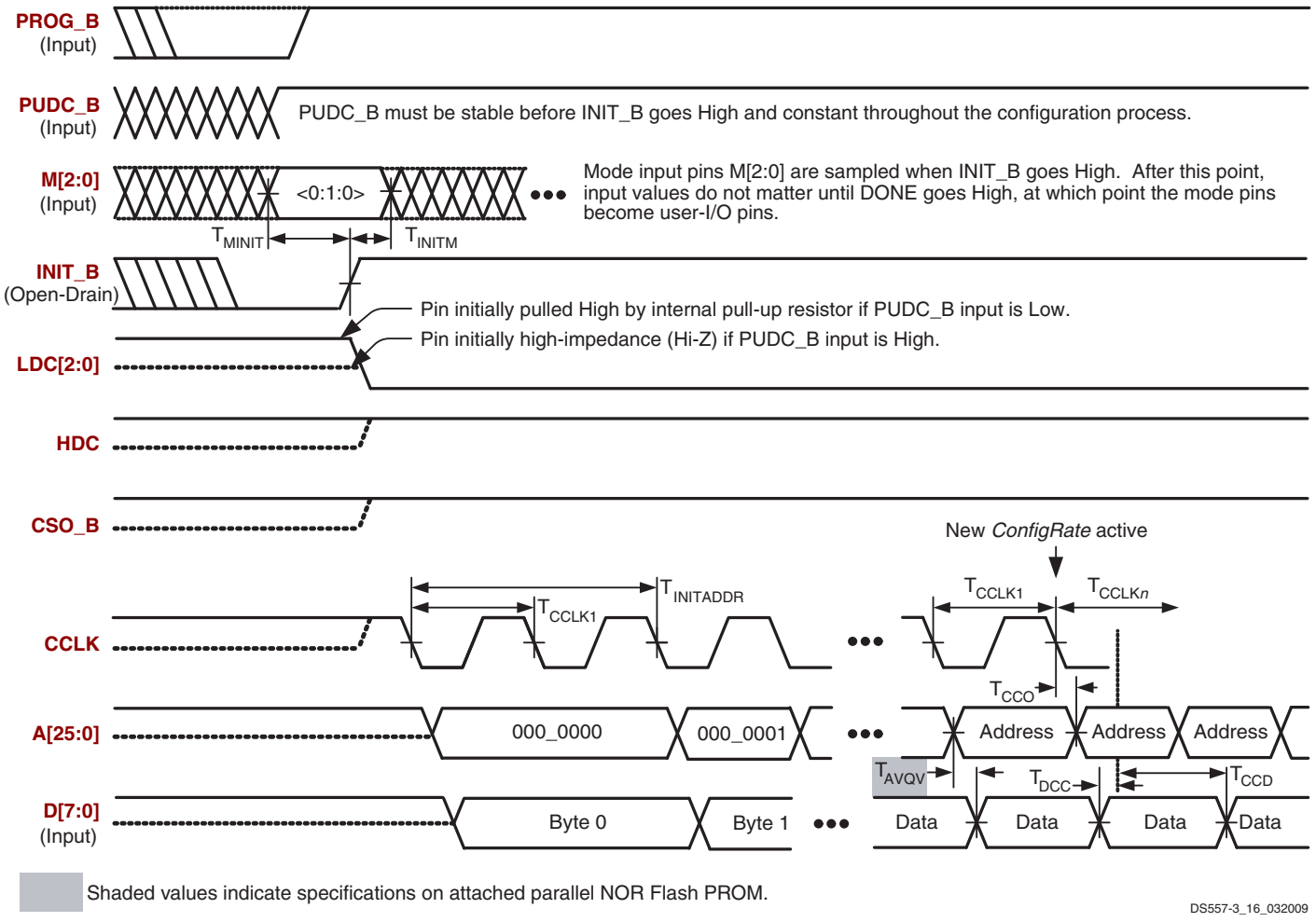

Figure 17: **Waveforms for Byte-wide Peripheral Interface (BPI) Configuration**

Introduction

This section describes how the various pins on a Spartan®-3AN FPGA connect within the supported component packages, and provides device-specific thermal characteristics. For general information on the pin functions and the package characteristics, see the Packaging section of UG331:

- **UG331: Spartan-3 Generation FPGA User Guide**
  http://www.xilinx.com/support/documentation/user_guides/ug331.pdf

Spartan-3AN FPGAs are available in Pb-free, RoHS packages, indicated by a "G" in the middle of the package code. Leaded (Pb) packages are available for selected devices, with the same pinout and without the "G" in the ordering code (see Table 5, page 7). The Pb-free package code can be selected in the software for the Pb packages since the pinouts are identical. References to the Pb-free package code in this document apply also to the Pb package.

Pin Types

Most pins on a Spartan-3AN FPGA are general-purpose, user-defined I/O pins. There are, however, up to 12 different functional types of pins on Spartan-3AN FPGA packages, as outlined in Table 62. In the package footprint drawings that follow, the individual pins are color-coded according to pin type as in the table.

Table 62: **Types of Pins on Spartan-3AN FPGAs**

Type with Color Code	Description	Pin Name(s) in Type(1)
I/O	Unrestricted, general-purpose user-I/O pin. Most pins can be paired together to form differential I/Os.	IO_# IO_Lxxy_#
INPUT	Unrestricted, general-purpose input-only pin. This pin does not have an output structure, differential termination resistor, or PCI™ clamp diode.	IP_# IP_Lxxy_#
DUAL	Dual-purpose pin used in some configuration modes during the configuration process and then usually available as a user I/O after configuration. If the pin is not used during configuration, this pin behaves as an I/O-type pin. See UG332: *Spartan-3 Generation Configuration User Guide* for additional information on these signals.	M[2:0] PUDC_B CCLK MOSI/CSI_B D[7:1] D0/DIN DOUT CSO_B RDWR_B INIT_B A[25:0] VS[2:0] LDC[2:0] HDC
VREF	Dual-purpose pin that is either a user-I/O pin or Input-only pin, or, along with all other VREF pins in the same bank, provides a reference voltage input for certain I/O standards. If used for a reference voltage within a bank, all VREF pins within the bank must be connected.	IP/VREF_# IP_Lxx_#/VREF_# IO/VREF_# IO_Lxx_#/VREF_#
CLK	Either a user-I/O pin or an input to a specific clock buffer driver. Most packages have 16 global clock inputs that optionally clock the entire device. The exceptions are all devices in the TQG144 package and the XC3S50AN in the FTG256 package. The RHCLK inputs optionally clock the right half of the device. The LHCLK inputs optionally clock the left half of the device. See the Using Global Clock Resources chapter in UG331: *Spartan-3 Generation FPGA User Guide* for additional information on these signals.	IO_Lxx_#/GCLK[15:0], IO_Lxx_#/LHCLK[7:0], IO_Lxx_#/RHCLK[7:0]

TQG144: 144-lead Thin Quad Flat Package

The XC3S50AN is available in the 144-lead thin quad flat package, TQG144.

Table 68 lists all the package pins. They are sorted by bank number and then by pin name. Pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type (as defined in Table 62). The XC3S50AN does not support the address output pins for the Byte-wide Peripheral Interface (BPI) configuration mode.

An electronic version of this package pinout table and footprint diagram is available for download from the Xilinx website at: www.xilinx.com/support/documentation/data_sheets/s3a_pin.zip.

Pinout Table

Table 68: **Spartan-3AN TQG144 Pinout**

Bank	Pin Name	Pin	Type
0	IO_0	P142	I/O
0	IO_L01N_0	P111	I/O
0	IO_L01P_0	P110	I/O
0	IO_L02N_0	P113	I/O
0	IO_L02P_0/VREF_0	P112	VREF
0	IO_L03N_0	P117	I/O
0	IO_L03P_0	P115	I/O
0	IO_L04N_0	P116	I/O
0	IO_L04P_0	P114	I/O
0	IO_L05N_0	P121	I/O
0	IO_L05P_0	P120	I/O
0	IO_L06N_0/GCLK5	P126	GCLK
0	IO_L06P_0/GCLK4	P124	GCLK
0	IO_L07N_0/GCLK7	P127	GCLK
0	IO_L07P_0/GCLK6	P125	GCLK
0	IO_L08N_0/GCLK9	P131	GCLK
0	IO_L08P_0/GCLK8	P129	GCLK
0	IO_L09N_0/GCLK11	P132	GCLK
0	IO_L09P_0/GCLK10	P130	GCLK
0	IO_L10N_0	P135	I/O
0	IO_L10P_0	P134	I/O
0	IO_L11N_0	P139	I/O
0	IO_L11P_0	P138	I/O
0	IO_L12N_0/PUDC_B	P143	DUAL
0	IO_L12P_0/VREF_0	P141	VREF
0	IP_0	P140	INPUT
0	IP_0/VREF_0	P123	VREF
0	VCCO_0	P119	VCCO
0	VCCO_0	P136	VCCO
1	IO_1	P79	I/O
1	IO_L01N_1/LDC2	P78	DUAL
1	IO_L01P_1/HDC	P76	DUAL
1	IO_L02N_1/LDC0	P77	DUAL

Table 68: **Spartan-3AN TQG144 Pinout *(Cont'd)***

Bank	Pin Name	Pin	Type
1	IO_L02P_1/LDC1	P75	DUAL
1	IO_L03N_1	P84	I/O
1	IO_L03P_1	P82	I/O
1	IO_L04N_1/RHCLK1	P85	RHCLK
1	IO_L04P_1/RHCLK0	P83	RHCLK
1	IO_L05N_1/TRDY1/RHCLK3	P88	RHCLK
1	IO_L05P_1/RHCLK2	P87	RHCLK
1	IO_L06N_1/RHCLK5	P92	RHCLK
1	IO_L06P_1/RHCLK4	P90	RHCLK
1	IO_L07N_1/RHCLK7	P93	RHCLK
1	IO_L07P_1/IRDY1/RHCLK6	P91	RHCLK
1	IO_L08N_1	P98	I/O
1	IO_L08P_1	P96	I/O
1	IO_L09N_1	P101	I/O
1	IO_L09P_1	P99	I/O
1	IO_L10N_1	P104	I/O
1	IO_L10P_1	P102	I/O
1	IO_L11N_1	P105	I/O
1	IO_L11P_1	P103	I/O
1	IP_1/VREF_1	P80	VREF
1	IP_1/VREF_1	P97	VREF
1	VCCO_1	P86	VCCO
1	VCCO_1	P95	VCCO
2	IO_2/MOSI/CSI_B	P62	DUAL
2	IO_L01N_2/M0	P38	DUAL
2	IO_L01P_2/M1	P37	DUAL
2	IO_L02N_2/CSO_B	P41	DUAL
2	IO_L02P_2/M2	P39	DUAL
2	IO_L03N_2/VS1	P44	DUAL
2	IO_L03P_2/RDWR_B	P42	DUAL
2	IO_L04N_2/VS0	P45	DUAL
2	IO_L04P_2/VS2	P43	DUAL
2	IO_L05N_2/D7	P48	DUAL

Table 70: **Spartan-3AN FTG256 Pinout (XC3S50AN, XC3S200AN, XC3S400AN) *(Cont'd)***

Bank	XC3S50AN Pin Name	XC3S200AN/XC3S400AN Pin Name	FTG256 Ball	Type
2	IP_2	IP_2	L7	INPUT
2	IP_2	IP_2	L8	INPUT
2	IP_2/VREF_2	IP_2/VREF_2	L9	VREF
2	IP_2/VREF_2	IP_2/VREF_2	L10	VREF
2	IP_2/VREF_2	IP_2/VREF_2	M7	VREF
2	IP_2/VREF_2	IP_2/VREF_2	M8	VREF
2	IP_2/VREF_2	IP_2/VREF_2	M11	VREF
2	IP_2/VREF_2	IP_2/VREF_2	N5	VREF
2	VCCO_2	VCCO_2	M9	VCCO
2	VCCO_2	VCCO_2	R4	VCCO
2	VCCO_2	VCCO_2	R8	VCCO
2	VCCO_2	VCCO_2	R12	VCCO
3	IO_L01N_3	IO_L01N_3	C1	I/O
3	IO_L01P_3	IO_L01P_3	C2	I/O
3	IO_L02N_3	IO_L02N_3	D3	I/O
3	IO_L02P_3	IO_L02P_3	D4	I/O
3	IO_L03N_3	IO_L03N_3	E1	I/O
3	IO_L03P_3	IO_L03P_3	D1	I/O
3	N.C.	IO_L05N_3	E2	I/O
3	N.C.	IO_L05P_3	E3	I/O
3	N.C.	IO_L07N_3	G4	I/O
3	N.C.	IO_L07P_3	F3	I/O
3	IO_L08N_3/VREF_3	IO_L08N_3/VREF_3	G1	VREF
3	IO_L08P_3	IO_L08P_3	F1	I/O
3	N.C.	IO_L09N_3	H4	I/O
3	N.C.	IO_L09P_3	G3	I/O
3	N.C.	IO_L10N_3	H5	I/O
3	N.C.	IO_L10P_3	H6	I/O
3	IO_L11N_3/LHCLK1	IO_L11N_3/LHCLK1	H1	LHCLK
3	IO_L11P_3/LHCLK0	IO_L11P_3/LHCLK0	G2	LHCLK
3	IO_L12N_3/IRDY2/LHCLK3	IO_L12N_3/IRDY2/LHCLK3	J3	LHCLK
3	IO_L12P_3/LHCLK2	IO_L12P_3/LHCLK2	H3	LHCLK
3	IO_L14N_3/LHCLK5	IO_L14N_3/LHCLK5	J1	LHCLK
3	IO_L14P_3/LHCLK4	IO_L14P_3/LHCLK4	J2	LHCLK
3	IO_L15N_3/LHCLK7	IO_L15N_3/LHCLK7	K1	LHCLK
3	IO_L15P_3/TRDY2/LHCLK6	IO_L15P_3/TRDY2/LHCLK6	K3	LHCLK
3	N.C.	IO_L16N_3	L2	I/O
3	N.C.	IO_L16P_3/VREF_3	L1	VREF
3	N.C.	IO_L17N_3	J6	I/O
3	N.C.	IO_L17P_3	J4	I/O

Table 73: **FTG256 XC3S50AN Footprint Migration/Differences *(Cont'd)***

FTG256 Ball	Bank	XC3S50AN	Migration	XC3S200AN or XC3S400AN
K13	1	N.C.	→	I/O
L1	3	N.C.	→	I/O/VREF
L2	3	N.C.	→	I/O
L3	3	N.C.	→	I/O
L4	3	N.C.	→	I/O
L13	1	N.C.	→	I/O
L14	1	N.C.	→	I/O
L16	1	N.C.	→	I/O
M3	3	N.C.	→	I/O
M10	2	N.C.	→	I/O
M13	1	N.C.	→	I/O
M14	1	N.C.	→	I/O/VREF
M15	1	N.C.	→	I/O
M16	1	N.C.	→	I/O
N7	2	N.C.	→	I/O
N10	2	N.C.	→	I/O
N12	2	N.C.	→	I/O
P6	2	N.C.	→	I/O
P13	2	N.C.	→	I/O
R7	2	N.C.	→	I/O
T7	2	N.C.	→	I/O
Number of Differences:			52	

XC3S50AN Differential I/O Alignment Differences

Also, some differential I/O pairs on the XC3S50AN FPGA are aligned differently than the corresponding pairs on the XC3S200AN or XC3S400AN FPGAs, as shown in Table 74. All the mismatched pairs are in I/O Bank 2. The N side of each pair is shaded.

Table 74: **Differential I/O Differences in FTG256**

FTG256 Ball	Bank	XC3S50AN	XC3S200AN or XC3S400AN
T3	2	IO_L04P_2/VS2	IO_L03N_2/VS2
N6		IO_L03N_2/VS1	IO_L04P_2/VS1
R5		IO_L06P_2	IO_L05N_2
T5		IO_L05N_2/D7	IO_L06P_2/D7
P10		IO_L14P_2/MOSI/CSI_B	IO_L14N_2/MOSI/CSI_B
T10		IO_L14N_2	IO_L14P_2
R13		IO_L20P_2	IO_L18N_2
T14		IO_L18N_2	IO_L20P_2

XC3S50AN Does Not Have BPI Mode Address Outputs

The XC3S50AN FPGA does not generate the BPI-mode address pins during configuration. Table 75 summarizes these differences.

Table 75: **XC3S50AN BPI Functional Differences**

FTG256 Ball	Bank	XC3S50AN	XC3S200AN or XC3S400AN
N16	1	IO_L03N_1	IO_L03N_1/A1
P16		IO_L03P_1	IO_L03P_1/A0
J13		IO_L10N_1	IO_L10N_1/A9
J12		IO_L10P_1	IO_L10P_1/A8
F13		IO_L20N_1	IO_L20N_1/A19
E14		IO_L20P_1	IO_L20P_1/A18
D15		IO_L22N_1	IO_L22N_1/A21
D16		IO_L22P_1	IO_L22P_1/A20
D14		IO_L23N_1	IO_L23N_1/A23
E13		IO_L23P_1	IO_L23P_1/A22
C15		IO_L24N_1	IO_L24N_1/A25
C16		IO_L24P_1	IO_L24P_1/A24

The Spartan-3AN FPGAs are pin compatible with the same density Spartan-3A FPGAs in the FT(G)256 package, although the Spartan-3A FPGAs require an external configuration source.

FTG256 Footprint (XC3S200AN, XC3S400AN)

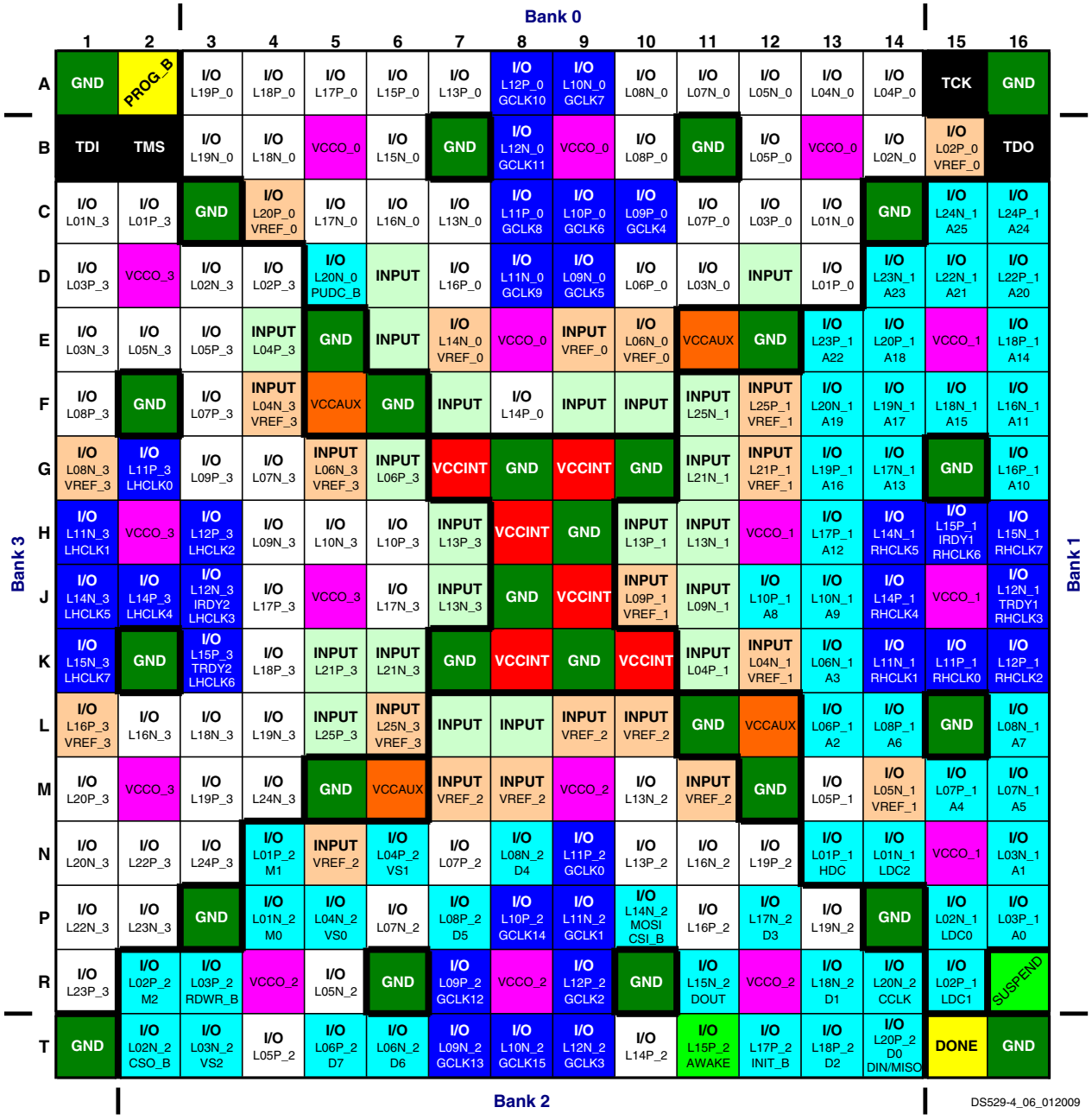

Figure 21: **XC3S200AN and XC3S400AN FPGA in FTG256 Package Footprint (Top View)**

69	**I/O:** Unrestricted, general-purpose user I/O	51	**DUAL:** Configuration pins, then possible user I/O	21	**VREF:** User I/O or input voltage reference for bank	2	**SUSPEND:** Dedicated SUSPEND and dual-purpose AWAKE Power Management pins
21	**INPUT:** Unrestricted, general-purpose input pin	32	**CLK:** User I/O, input, or global buffer input	16	**VCCO:** Output voltage supply for bank		
2	**CONFIG:** Dedicated configuration pins	4	**JTAG:** Dedicated JTAG port pins	6	**VCCINT:** Internal core supply voltage (+1.2V)		
0	**N.C.:** Not connected	28	**GND:** Ground	4	**VCCAUX:** Auxiliary supply voltage		

Table 76: **Spartan-3AN FGG400 Pinout *(Cont'd)***

Bank	Pin Name	FGG400 Ball	Type
2	IO_L28P_2	Y16	I/O
2	IO_L29N_2	U16	I/O
2	IO_L29P_2	V16	I/O
2	IO_L30N_2	Y18	I/O
2	IO_L30P_2	Y17	I/O
2	IO_L31N_2	U17	I/O
2	IO_L31P_2	V17	I/O
2	IO_L32N_2/CCLK	Y19	DUAL
2	IO_L32P_2/D0/DIN/MISO	W18	DUAL
2	IP_2	P9	INPUT
2	IP_2	P12	INPUT
2	IP_2	P13	INPUT
2	IP_2	R8	INPUT
2	IP_2	R10	INPUT
2	IP_2	T11	INPUT
2	IP_2/VREF_2	N9	VREF
2	IP_2/VREF_2	N12	VREF
2	IP_2/VREF_2	P8	VREF
2	IP_2/VREF_2	P10	VREF
2	IP_2/VREF_2	P11	VREF
2	IP_2/VREF_2	R14	VREF
2	VCCO_2	R11	VCCO
2	VCCO_2	U8	VCCO
2	VCCO_2	U14	VCCO
2	VCCO_2	W5	VCCO
2	VCCO_2	W11	VCCO
2	VCCO_2	W17	VCCO
3	IO_L01N_3	D3	I/O
3	IO_L01P_3	D4	I/O
3	IO_L02N_3	C2	I/O
3	IO_L02P_3	B1	I/O
3	IO_L03N_3	D2	I/O
3	IO_L03P_3	C1	I/O
3	IO_L05N_3	E1	I/O
3	IO_L05P_3	D1	I/O
3	IO_L06N_3	G5	I/O
3	IO_L06P_3	F4	I/O
3	IO_L07N_3	J5	I/O
3	IO_L07P_3	J6	I/O
3	IO_L08N_3	H4	I/O

Table 76: **Spartan-3AN FGG400 Pinout *(Cont'd)***

Bank	Pin Name	FGG400 Ball	Type
3	IO_L08P_3	H6	I/O
3	IO_L09N_3	G4	I/O
3	IO_L09P_3	F3	I/O
3	IO_L10N_3	F2	I/O
3	IO_L10P_3	E3	I/O
3	IO_L12N_3	H2	I/O
3	IO_L12P_3	G3	I/O
3	IO_L13N_3/VREF_3	G1	VREF
3	IO_L13P_3	F1	I/O
3	IO_L14N_3	H3	I/O
3	IO_L14P_3	J4	I/O
3	IO_L16N_3	J2	I/O
3	IO_L16P_3	J3	I/O
3	IO_L17N_3/LHCLK1	K2	LHCLK
3	IO_L17P_3/LHCLK0	J1	LHCLK
3	IO_L18N_3/IRDY2/LHCLK3	L3	LHCLK
3	IO_L18P_3/LHCLK2	K3	LHCLK
3	IO_L20N_3/LHCLK5	L5	LHCLK
3	IO_L20P_3/LHCLK4	K4	LHCLK
3	IO_L21N_3/LHCLK7	M1	LHCLK
3	IO_L21P_3/TRDY2/LHCLK6	L1	LHCLK
3	IO_L22N_3	M3	I/O
3	IO_L22P_3/VREF_3	M2	VREF
3	IO_L24N_3	M5	I/O
3	IO_L24P_3	M4	I/O
3	IO_L25N_3	N2	I/O
3	IO_L25P_3	N1	I/O
3	IO_L26N_3	N4	I/O
3	IO_L26P_3	N3	I/O
3	IO_L28N_3	R1	I/O
3	IO_L28P_3	P1	I/O
3	IO_L29N_3	P4	I/O
3	IO_L29P_3	P3	I/O
3	IO_L30N_3	R3	I/O
3	IO_L30P_3	R2	I/O
3	IO_L32N_3	T2	I/O
3	IO_L32P_3/VREF_3	T1	VREF
3	IO_L33N_3	R4	I/O
3	IO_L33P_3	T3	I/O
3	IO_L34N_3	U3	I/O

Table 78: **Spartan-3AN FGG484 Pinout *(Cont'd)***

Bank	Pin Name	FGG484 Ball	Type
1	IO_L25N_1/RHCLK7	K19	RHCLK
1	IO_L25P_1/IRDY1/RHCLK6	K20	RHCLK
1	IO_L26N_1/A11	J22	DUAL
1	IO_L26P_1/A10	K22	DUAL
1	IO_L28N_1	L19	I/O
1	IO_L28P_1	L18	I/O
1	IO_L29N_1/A13	J20	DUAL
1	IO_L29P_1/A12	J21	DUAL
1	IO_L30N_1/A15	G22	DUAL
1	IO_L30P_1/A14	H22	DUAL
1	IO_L32N_1	K18	I/O
1	IO_L32P_1	K17	I/O
1	IO_L33N_1/A17	H20	DUAL
1	IO_L33P_1/A16	H21	DUAL
1	IO_L34N_1/A19	F21	DUAL
1	IO_L34P_1/A18	F22	DUAL
1	IO_L36N_1	G20	I/O
1	IO_L36P_1	G19	I/O
1	IO_L37N_1	H19	I/O
1	IO_L37P_1	J18	I/O
1	IO_L38N_1	F20	I/O
1	IO_L38P_1	E20	I/O
1	IO_L40N_1	F18	I/O
1	IO_L40P_1	F19	I/O
1	IO_L41N_1	D22	I/O
1	IO_L41P_1	E22	I/O
1	IO_L42N_1	D20	I/O
1	IO_L42P_1	D21	I/O
1	IO_L44N_1/A21	C21	DUAL
1	IO_L44P_1/A20	C22	DUAL
1	IO_L45N_1/A23	B21	DUAL
1	IO_L45P_1/A22	B22	DUAL
1	IO_L46N_1/A25	G17	DUAL
1	IO_L46P_1/A24	G18	DUAL
1	IP_L04N_1/VREF_1	R16	VREF
1	IP_L04P_1	R15	INPUT
1	IP_L08N_1	P16	INPUT
1	IP_L08P_1	P15	INPUT
1	IP_L12N_1/VREF_1	R18	VREF
1	IP_L12P_1	R17	INPUT

Table 78: **Spartan-3AN FGG484 Pinout *(Cont'd)***

Bank	Pin Name	FGG484 Ball	Type
1	IP_L16N_1/VREF_1	N16	VREF
1	IP_L16P_1	N15	INPUT
1	IP_L23N_1	M16	INPUT
1	IP_L23P_1	M17	INPUT
1	IP_L27N_1	L16	INPUT
1	IP_L27P_1/VREF_1	M15	VREF
1	IP_L31N_1	K16	INPUT
1	IP_L31P_1	L15	INPUT
1	IP_L35N_1	K15	INPUT
1	IP_L35P_1/VREF_1	K14	VREF
1	IP_L39N_1	H18	INPUT
1	IP_L39P_1	H17	INPUT
1	IP_L43N_1/VREF_1	J15	VREF
1	IP_L43P_1	J16	INPUT
1	IP_L47N_1	H15	INPUT
1	IP_L47P_1/VREF_1	H16	VREF
1	VCCO_1	E21	VCCO
1	VCCO_1	J17	VCCO
1	VCCO_1	K21	VCCO
1	VCCO_1	P17	VCCO
1	VCCO_1	P21	VCCO
1	VCCO_1	V21	VCCO
2	IO_L01N_2/M0	W5	DUAL
2	IO_L01P_2/M1	V6	DUAL
2	IO_L02N_2/CSO_B	Y4	DUAL
2	IO_L02P_2/M2	W4	DUAL
2	IO_L03N_2	AA3	I/O
2	IO_L03P_2	AB2	I/O
2	IO_L04N_2	AA4	I/O
2	IO_L04P_2	AB3	I/O
2	IO_L05N_2	Y5	I/O
2	IO_L05P_2	W6	I/O
2	IO_L06N_2	AB5	I/O
2	IO_L06P_2	AB4	I/O
2	IO_L07N_2	Y6	I/O
2	IO_L07P_2	W7	I/O
2	IO_L08N_2	AB6	I/O
2	IO_L08P_2	AA6	I/O
2	IO_L09N_2/VS2	W9	DUAL
2	IO_L09P_2/RDWR_B	V9	DUAL

Table 78: **Spartan-3AN FGG484 Pinout *(Cont'd)***

Bank	Pin Name	FGG484 Ball	Type
2	VCCO_2	AA13	VCCO
2	VCCO_2	AA18	VCCO
2	VCCO_2	AA5	VCCO
2	VCCO_2	AA9	VCCO
2	VCCO_2	U14	VCCO
2	VCCO_2	U9	VCCO
3	IO_L01N_3	D2	I/O
3	IO_L01P_3	C1	I/O
3	IO_L02N_3	C2	I/O
3	IO_L02P_3	B1	I/O
3	IO_L03N_3	E4	I/O
3	IO_L03P_3	D3	I/O
3	IO_L05N_3	G5	I/O
3	IO_L05P_3	G6	I/O
3	IO_L06N_3	E1	I/O
3	IO_L06P_3	D1	I/O
3	IO_L07N_3	E3	I/O
3	IO_L07P_3	F4	I/O
3	IO_L08N_3	G4	I/O
3	IO_L08P_3	F3	I/O
3	IO_L09N_3	H6	I/O
3	IO_L09P_3	H5	I/O
3	IO_L10N_3	J5	I/O
3	IO_L10P_3	K6	I/O
3	IO_L12N_3	F1	I/O
3	IO_L12P_3	F2	I/O
3	IO_L13N_3	G1	I/O
3	IO_L13P_3	G3	I/O
3	IO_L14N_3	H3	I/O
3	IO_L14P_3	H4	I/O
3	IO_L16N_3	H1	I/O
3	IO_L16P_3	H2	I/O
3	IO_L17N_3/VREF_3	J1	VREF
3	IO_L17P_3	J3	I/O
3	IO_L18N_3	K4	I/O
3	IO_L18P_3	K5	I/O
3	IO_L20N_3	K2	I/O
3	IO_L20P_3	K3	I/O
3	IO_L21N_3/LHCLK1	L3	LHCLK
3	IO_L21P_3/LHCLK0	L5	LHCLK

Table 78: **Spartan-3AN FGG484 Pinout *(Cont'd)***

Bank	Pin Name	FGG484 Ball	Type
3	IO_L22N_3/IRDY2/LHCLK3	L1	LHCLK
3	IO_L22P_3/LHCLK2	K1	LHCLK
3	IO_L24N_3/LHCLK5	M2	LHCLK
3	IO_L24P_3/LHCLK4	M1	LHCLK
3	IO_L25N_3/LHCLK7	M4	LHCLK
3	IO_L25P_3/TRDY2/LHCLK6	M3	LHCLK
3	IO_L26N_3	N3	I/O
3	IO_L26P_3/VREF_3	N1	VREF
3	IO_L28N_3	P2	I/O
3	IO_L28P_3	P1	I/O
3	IO_L29N_3	P5	I/O
3	IO_L29P_3	P3	I/O
3	IO_L30N_3	N4	I/O
3	IO_L30P_3	M5	I/O
3	IO_L32N_3	R2	I/O
3	IO_L32P_3	R1	I/O
3	IO_L33N_3	R4	I/O
3	IO_L33P_3	R3	I/O
3	IO_L34N_3	T4	I/O
3	IO_L34P_3	R5	I/O
3	IO_L36N_3	T3	I/O
3	IO_L36P_3/VREF_3	T1	VREF
3	IO_L37N_3	U2	I/O
3	IO_L37P_3	U1	I/O
3	IO_L38N_3	V3	I/O
3	IO_L38P_3	V1	I/O
3	IO_L40N_3	U5	I/O
3	IO_L40P_3	T5	I/O
3	IO_L41N_3	U4	I/O
3	IO_L41P_3	U3	I/O
3	IO_L42N_3	W2	I/O
3	IO_L42P_3	W1	I/O
3	IO_L43N_3	W3	I/O
3	IO_L43P_3	V4	I/O
3	IO_L44N_3	Y2	I/O
3	IO_L44P_3	Y1	I/O
3	IO_L45N_3	AA2	I/O
3	IO_L45P_3	AA1	I/O
3	IP_3/VREF_3	J8	VREF
3	IP_3/VREF_3	R6	VREF

Table 82: **Spartan-3AN FGG676 Pinout *(Cont'd)***

Bank	Pin Name	FGG676 Ball	Type
0	IO_L33N_0	B10	I/O
0	IO_L33P_0	A10	I/O
0	IO_L34N_0	D10	I/O
0	IO_L34P_0	C10	I/O
0	IO_L35N_0	H12	I/O
0	IO_L35P_0	G12	I/O
0	IO_L36N_0	B9	I/O
0	IO_L36P_0	A9	I/O
0	IO_L37N_0	D9	I/O
0	IO_L37P_0	E10	I/O
0	IO_L38N_0	B8	I/O
0	IO_L38P_0	A8	I/O
0	IO_L39N_0	K12	I/O
0	IO_L39P_0	J12	I/O
0	IO_L40N_0	D8	I/O
0	IO_L40P_0	C8	I/O
0	IO_L41N_0	C6	I/O
0	IO_L41P_0	B6	I/O
0	IO_L42N_0	C7	I/O
0	IO_L42P_0	B7	I/O
0	IO_L43N_0	K11	I/O
0	IO_L43P_0	J11	I/O
0	IO_L44N_0	D6	I/O
0	IO_L44P_0	C5	I/O
0	IO_L45N_0	B4	I/O
0	IO_L45P_0	A4	I/O
0	IO_L46N_0	H10	I/O
0	IO_L46P_0	G10	I/O
0	IO_L47N_0	H9	I/O
0	IO_L47P_0	G9	I/O
0	IO_L48N_0	E7	I/O
0	IO_L48P_0	F7	I/O
0	IO_L51N_0	B3	I/O
0	IO_L51P_0	A3	I/O
0	IO_L52N_0/PUDC_B	G8	DUAL
0	IO_L52P_0/VREF_0	F8	VREF
0	IP_0	A5	INPUT
0	IP_0	A7	INPUT
0	IP_0	A13	INPUT
0	IP_0	A17	INPUT

Table 82: **Spartan-3AN FGG676 Pinout *(Cont'd)***

Bank	Pin Name	FGG676 Ball	Type
0	IP_0	A23	INPUT
0	IP_0	C4	INPUT
0	IP_0	D12	INPUT
0	IP_0	D15	INPUT
0	IP_0	D19	INPUT
0	IP_0	E11	INPUT
0	IP_0	E18	INPUT
0	IP_0	E20	INPUT
0	IP_0	F10	INPUT
0	IP_0	G14	INPUT
0	IP_0	G16	INPUT
0	IP_0	H13	INPUT
0	IP_0	H18	INPUT
0	IP_0	J10	INPUT
0	IP_0	J13	INPUT
0	IP_0	J15	INPUT
0	IP_0/VREF_0	D7	VREF
0	IP_0/VREF_0	D14	VREF
0	IP_0/VREF_0	G11	VREF
0	IP_0/VREF_0	J17	VREF
0	N.C.	A24	N.C.
0	N.C.	B24	N.C.
0	N.C.	D5	N.C.
0	N.C.	E9	N.C.
0	N.C.	F18	N.C.
0	N.C.	E6	N.C.
0	N.C.	F9	N.C.
0	N.C.	G18	N.C.
0	VCCO_0	B5	VCCO
0	VCCO_0	B11	VCCO
0	VCCO_0	B16	VCCO
0	VCCO_0	B22	VCCO
0	VCCO_0	E8	VCCO
0	VCCO_0	E13	VCCO
0	VCCO_0	E19	VCCO
0	VCCO_0	H11	VCCO
0	VCCO_0	H16	VCCO
1	IO_L01N_1/LDC2	Y21	DUAL
1	IO_L01P_1/HDC	Y20	DUAL
1	IO_L02N_1/LDC0	AD25	DUAL

Table 82: **Spartan-3AN FGG676 Pinout *(Cont'd)***

Bank	Pin Name	FGG676 Ball	Type
2	IP_2	AD9	INPUT
2	IP_2	AD10	INPUT
2	IP_2	AD16	INPUT
2	IP_2	AF2	INPUT
2	IP_2	AF7	INPUT
2	IP_2	Y11	INPUT
2	IP_2/VREF_2	AA9	VREF
2	IP_2/VREF_2	AA20	VREF
2	IP_2/VREF_2	AB6	VREF
2	IP_2/VREF_2	AB10	VREF
2	IP_2/VREF_2	AC10	VREF
2	IP_2/VREF_2	AD12	VREF
2	IP_2/VREF_2	AF15	VREF
2	IP_2/VREF_2	AF17	VREF
2	IP_2/VREF_2	AF22	VREF
2	IP_2/VREF_2	Y16	VREF
2	N.C.	AA8	N.C.
2	N.C.	AC5	N.C.
2	N.C.	AC22	N.C.
2	N.C.	AD5	N.C.
2	N.C.	Y18	N.C.
2	N.C.	Y19	N.C.
2	N.C.	AD23	N.C.
2	N.C.	W18	N.C.
2	N.C.	Y8	N.C.
2	VCCO_2	AB8	VCCO
2	VCCO_2	AB14	VCCO
2	VCCO_2	AB19	VCCO
2	VCCO_2	AE5	VCCO
2	VCCO_2	AE11	VCCO
2	VCCO_2	AE16	VCCO
2	VCCO_2	AE22	VCCO
2	VCCO_2	W11	VCCO
2	VCCO_2	W16	VCCO
3	IO_L01N_3	J9	I/O
3	IO_L01P_3	J8	I/O
3	IO_L02N_3	B1	I/O
3	IO_L02P_3	B2	I/O
3	IO_L03N_3	H7	I/O
3	IO_L03P_3	G6	I/O

Table 82: **Spartan-3AN FGG676 Pinout *(Cont'd)***

Bank	Pin Name	FGG676 Ball	Type
3	IO_L05N_3	K8	I/O
3	IO_L05P_3	K9	I/O
3	IO_L06N_3	E4	I/O
3	IO_L06P_3	D3	I/O
3	IO_L07N_3	F4	I/O
3	IO_L07P_3	E3	I/O
3	IO_L09N_3	G4	I/O
3	IO_L09P_3	F5	I/O
3	IO_L10N_3	H6	I/O
3	IO_L10P_3	J7	I/O
3	IO_L11N_3	F2	I/O
3	IO_L11P_3	E1	I/O
3	IO_L13N_3	J6	I/O
3	IO_L13P_3	K7	I/O
3	IO_L14N_3	F3	I/O
3	IO_L14P_3	G3	I/O
3	IO_L15N_3	L9	I/O
3	IO_L15P_3	L10	I/O
3	IO_L17N_3	H1	I/O
3	IO_L17P_3	H2	I/O
3	IO_L18N_3	L7	I/O
3	IO_L18P_3	K6	I/O
3	IO_L19N_3	J4	I/O
3	IO_L19P_3	J5	I/O
3	IO_L21N_3	M9	I/O
3	IO_L21P_3	M10	I/O
3	IO_L22N_3	K4	I/O
3	IO_L22P_3	K5	I/O
3	IO_L23N_3	K2	I/O
3	IO_L23P_3	K3	I/O
3	IO_L25N_3	L3	I/O
3	IO_L25P_3	L4	I/O
3	IO_L26N_3	M7	I/O
3	IO_L26P_3	M8	I/O
3	IO_L27N_3	M3	I/O
3	IO_L27P_3	M4	I/O
3	IO_L28N_3	M6	I/O
3	IO_L28P_3	M5	I/O
3	IO_L29N_3/VREF_3	M1	VREF
3	IO_L29P_3	M2	I/O